

IN THE CLAIMS:

Please AMEND claims 3, 10, 12-14 and 20, as follows. For the Examiner's convenience, all claims currently pending in this application have been reproduced below:

1. (Cancelled)

2. (Previously Presented) An aberration changing optical system for changing an aberration, said aberration changing optical system comprising:

an optical element having different refracting powers in two orthogonal directions or having a refracting power in one direction of two orthogonal directions and no refracting power in the other of the two orthogonal directions, said optical element being rotatable about a rotational axis, which is an optical axis of said optical system, and being tiltable relative to the optical axis.

3. (Currently Amended) An aberration changing optical system according to Claim 2, wherein said aberration changing optical system comprises a plurality of said optical elements, and

wherein one of said plurality of optical elements is used selectively to change the aberration.

4. (Previously Presented) An aberration changing optical system according to Claim 2, wherein said aberration changing optical system comprises a pair of said optical elements, and wherein said pair of optical elements are made rotatable and tilttable integrally and further tilttable in mutually opposite directions.

5. (Previously Presented) An aberration changing optical system according to Claim 2, further comprising a parallel flat plate being rotatable about the optical axis of said optical system and tilttable relative to the optical axis, integrally with the optical element, said parallel flat plate further being tilttable in an opposite direction to said optical element.

6. (Previously Presented) An aberration changing optical system according to Claim 2, wherein said optical element is mainly composed of a transparent material of one of quartz and fluorite.

7. (Previously Presented) An aberration changing optical system according to Claim 2, wherein the or each surface of said optical element, having a refracting power, has a refractive power not greater than $3 \times 10^{-7} \text{ mm}^{-1}$.

8. (Previously Presented) A projection system, comprising:
a projection optical system; and

an aberration changing optical system as recited in Claim 2, for correcting aberration produced in said projection optical system.

9. (Previously Presented) A projection exposure apparatus, comprising:

an illumination system; and
a projection system for projecting a pattern of a mask onto a substrate in cooperation with said illumination system, said projection system including a projection optical system and an aberration changing optical system, as recited in Claim 2, for correcting aberration produced in said projection optical system.

10. (Currently Amended) A device manufacturing method, including comprising:

a process for transferring a device pattern onto a wafer substrate by use of a projection exposure apparatus as recited in Claim 9.

11. (Cancelled)

12. (Currently Amended) A projection system for projecting a pattern of a mask onto a substrate, said projection system comprising:

a projection optical system disposed between the mask and the wafer substrate; and

an optical element for correcting aberration produced in said projection optical system, said optical element having different refracting powers in two orthogonal directions or having a refracting power in one direction of two orthogonal directions and no refracting power in the other of the two orthogonal directions, and said optical element being disposed between the mask and the ~~wafer~~ and being substrate, wherein an optical axis of said optical element is inclined with respect to an optical axis of said projection optical system.

13. (Currently Amended) A projection system according to Claim 12, wherein said projection system comprises a plurality of said optical elements, and
wherein one of said plurality of optical elements is used selectively to change the aberration.

14. (Currently Amended) A projection system according to Claim 12, wherein said projection system ~~comprise~~ comprises a pair of said optical elements, and
wherein said pair of optical elements are made rotatable and tiltable integrally and further tiltable in mutually opposite directions.

15. (Previously Presented) A projection system according to Claim 12, further comprising a parallel flat plate being inclined with respect to the optical axis and in an opposite direction to said optical element.

16. (Previously Presented) A projection system according to Claim 12, wherein said optical element is mainly composed of a transparent material of one of quartz and fluorite.

17. (Previously Presented) A projection system according to Claim 12, wherein the or each surface of said optical element, having a refracting power, has a refractive power not greater than $3 \times 10^{-7} \text{ mm}^{-1}$.

18. (Cancelled)

19. (Previously Presented) A projection exposure apparatus, comprising:
an illumination system for illuminating a mask; and
a projection system as recited in Claim 12 for projecting a pattern of the mask onto a substrate.

20. (Currently Amended) A device manufacturing method, including comprising:
a process for transferring a device pattern onto a wafer substrate by use of a projection exposure apparatus as recited in Claim 19.